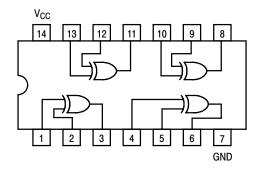
## **Quad 2-Input Exclusive OR Gate**



#### **TRUTH TABLE**

II.	OUT	
Α	В	Z
L	L	L
L	Н	Н
Н	L	H
Н	Н	L

#### **GUARANTEED OPERATING RANGES**

Symbol	Parameter	Min	Тур	Max	Unit	
V <sub>CC</sub>	Supply Voltage	4.75	5.0	5.25	V	
T <sub>A</sub>	Operating Ambient Temperature Range	0	25	70	ô	
I <sub>OH</sub>	Output Current - High			-0.4	mA	
I <sub>OL</sub>	Output Current - Low			8.0	mA	
PLEASEPALS						



### ON Semiconductor™

http://onsemi.com

# LOW POWER SCHOTTKY



PLASTIC N SUFFIX CASE 646



SOIC D SUFFIX CASE 751A



SOEIAJ M SUFFIX CASE 965

#### **ORDERING INFORMATION**

Device	Package	Shipping
SN74LS86N	14 Pin DIP	2000 Units/Box
SN74LS86D	SOIC-14	55 Units/Rail
SN74LS86DR2	SOIC-14	2500/Tape & Reel
SN74LS86M	SOEIAJ-14	See Note 1
SN74LS86MEL	SOEIAJ-14	See Note 1

 For ordering information on the EIAJ version of the SOIC package, please contact your local ON Semiconductor representative.

#### DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

		Limits		Limits			
Symbol	Parameter	Min	Тур	Max	Unit	Test Co	onditions
V <sub>IH</sub>	Input HIGH Voltage	2.0			٧	Guaranteed Input HIGH Voltage for All Inputs	
V <sub>IL</sub>	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage for All Inputs	
V <sub>IK</sub>	Input Clamp Diode Voltage		-0.65	-1.5	V	V <sub>CC</sub> = MIN, I <sub>IN</sub> = -18 mA	
V <sub>OH</sub>	Output HIGH Voltage	2.7	3.5		V	$V_{CC}$ = MIN, $I_{OH}$ = MAX, $V_{IN}$ = $V_{IH}$ or $V_{IL}$ per Truth Table	
.,	O to 11 OW/Velley		0.25	0.4	V		V <sub>CC</sub> = V <sub>CC</sub> MIN,
$V_{OL}$	Output LOW Voltage		0.35	0.5	V	I <sub>OL</sub> = 8.0 mA	$V_{IN} = V_{IL}$ or $V_{IH}$ per Truth Table
	Innert HCH Current			40	μΑ	V <sub>CC</sub> = MAX, V <sub>IN</sub> =	= 2.7 V
I <sub>IH</sub>	Input HIGH Current			0.2	mA	V <sub>CC</sub> = MAX, V <sub>IN</sub> =	= 7.0 V
I <sub>IL</sub>	Input LOW Current			-0.8	mA	V <sub>CC</sub> = MAX, V <sub>IN</sub> = 0.4 V	
I <sub>OS</sub>	Short Circuit Current (Note 2)	-20		-100	mA	V <sub>CC</sub> = MAX	
I <sub>CC</sub>	Power Supply Current			10	mA	V <sub>CC</sub> = MAX	

<sup>2.</sup> Not more than one output should be shorted at a time, nor for more than 1 second.

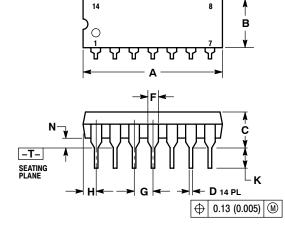
## **AC CHARACTERISTICS** (T<sub>A</sub> = 25°C)

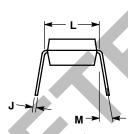
			Limits	ر ک			
Symbol	Parameter	Min	Тур	Max	Unit	O'lla.	Test Conditions
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay, Other Input LOW		12 10	23 17	ns	O,	V <sub>CC</sub> = 5.0 V
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay, Other Input HIGH	<b>C</b>	20 13	30 22	ns		C <sub>L</sub> = 15 pF
	O HILLS OF CONTRACTOR OF THE PRESENT		TIME				

#### PACKAGE DIMENSIONS

#### **N SUFFIX**

PLASTIC PACKAGE CASE 646-06 ISSUE M

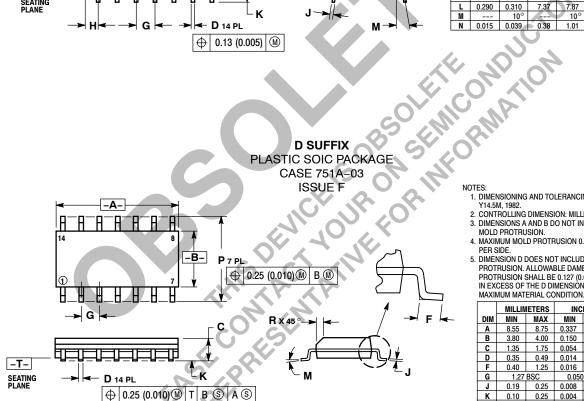




- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEADS WHEN
  - FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.
   ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.715	0.770	18.16	18.80	
В	0.240	0.260	6.10	6.60	
С	0.145	0.185	3.69	4.69	
D	0.015	0.021	0.38	0.53	
F	0.040	0.070	1.02	1.78	
G	0.100	BSC	2.54 BSC		
Н	0.052	0.095	1.32	2.41	
J	0.008	0.015	0.20	0.38	
K	0.115	0.135	2.92	3.43	
L	0.290	0.310	7.37	7.87	
M		10°	4	10°	
N	0.015	0.039	0.38	1.01	





- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
- 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006)
- PEH SIDE.

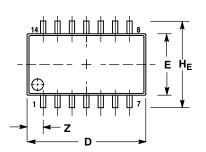
  5. DIMENSION D DOES NOT INCLUDE DAMBAR
  PROTRUSION. ALLOWABLE DAMBAR
  PROTRUSION SHALL BE 0.127 (0.005) TOTAL
  IN EXCESS OF THE D DIMENSION AT
  MAXIMUM MATERIAL CONDITION.

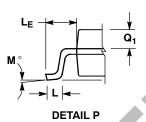
	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	8.55	8.75	0.337	0.344	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	BSC	0.050	BSC	
J	0.19	0.25	0.008	0.009	
K	0.10	0.25	0.004	0.009	
M	0 °	7°	0°	7°	
Р	5.80	6.20	0.228	0.244	
R	0.25	0.50	0.010	0.019	

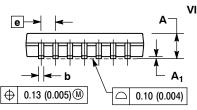
#### PACKAGE DIMENSIONS

#### **M SUFFIX**

SOEIAJ PACKAGE CASE 965-01 **ISSUE O** 









- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
  DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 ( 0.018).

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	-	2.05		0.081
A <sub>1</sub>	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
C	0.18	0.27	0.007	0.011
a	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
е	1.27	BSC	0.050	BSC
HE	7.40	8.20	0.291	0.323
0.50	0.50	0.85	0.020	0.033
L <sub>E</sub>	1.10	1.50	0.043	0.059
M	0 °	10°	0 °	10°
Q	0.70	0.90	0.028	0.035
Z		1.42		0.056

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